PNP Silicon Epitaxial Planar Transistor



1.Base 2.Collector 3.Emitter SOT-89 Plastic Package

Absolute Maximum Ratings (T_a = 25°C)

Parameter	Symbol	Value	Unit
Collector Base Voltage	-V _{CBO}	60	V
Collector Emitter Voltage	-V _{CEO}	-V _{CEO} 50	
Emitter Base Voltage	-V _{EBO}	6	V
Collector Current	-lc	3	Α
Collector Current (Pulse)	-I _{CP}	6	Α
Collector Power Dissipation	Pc	0.5 ¹⁾ 1 ²⁾	W
Junction Temperature	Tj	150	°C
Storage Temperature Range	T _{stg}	- 55 to + 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	250 ¹⁾ 125 ²⁾	°C/W

¹⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.

2SB1124U

Characteristics at $T_a = 25$ °C

Deremeter		Cumbal	Min	Turn	May	Linit
Parameter	Symbol	Min.	Тур.	Max.	Unit	
DC Current Gain at -V _{CE} = 2 V, -I _C = 100 mA Current Gain Group at -V _{CE} = 2 V, -I _C = 3 A	A B C	h _{FE} h _{FE} h _{FE}	100 140 200 35	- - -	200 280 400	- - -
Collector Base Cutoff Current at -V _{CB} = 40 V		-Ісво	-	-	1	μA
Emitter Base Cutoff Current at -V _{EB} = 4 V		-I _{EBO}	-	-	1	μΑ
Collector Base Breakdown Voltage at -l _C = 100 μA	-V _{(BR)CBO}	60	-	-	V	
Collector Emitter Breakdown Voltage at -l _c = 10 mA	-V _{(BR)CEO}	50	-	-	V	
Emitter Base Breakdown Voltage at -I _E = 100 μA	-V _{(BR)EBO}	6	-	-	V	
Collector Emitter Saturation Voltage at -I _C = 2 A, -I _B = 100 mA	-V _{CE(sat)}	-	-	0.7	V	
Base Emitter Saturation Voltage at $-I_C = 2 A$, $-I_B = 100 \text{ mA}$		-V _{BE(sat)}	-	-	1.2	V
Transition Frequency at $-V_{CE} = 10 \text{ V}$, $-I_C = 50 \text{ mA}$		f⊤	-	150	-	MHz
Collector Output Capacitance at -V _{CB} = 10 V, f = 1 MHz	C _{ob}	-	30	-	pF	
Turn on Time at -V _{CC} = 10 V, -I _C = 500 mA, -I _{B1} = -I _{B2} = 50 mA		t _{on}	-	40	-	ns
Turn off Time at -V _{CC} = 10 V, -I _C = 500 mA, -I _{B1} = -I _{B2} = 50 mA	t _{off}	-	450	-	ns	



Electrical Characteristics Curves

Fig. 1 Output Characteristics Curve

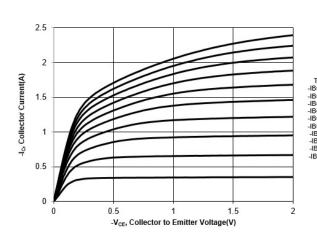


Fig. 2 Collector Curren vs. V_{BE}

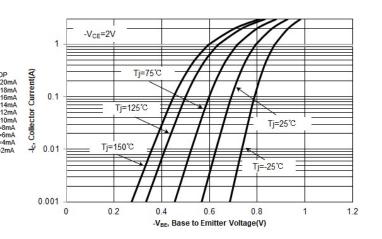


Fig. 3 hFE vs. Collector Current

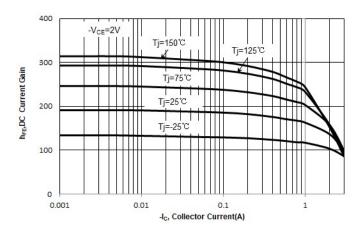
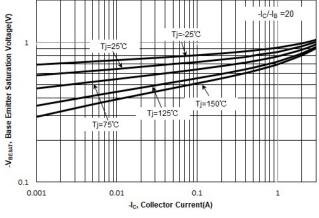


Fig. 4 V_{BE(sat)} vs. Collector Current





Electrical Characteristics Curves

Fig. 5 V_{CE(sat)} vs. Collector Current

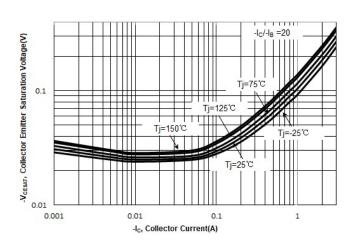


Fig 6. Output Capacitance

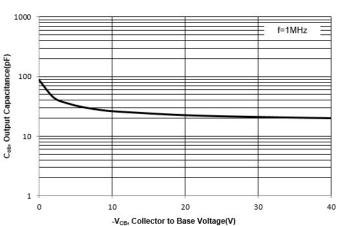
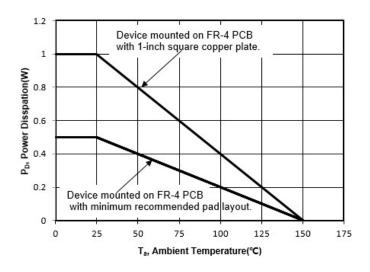


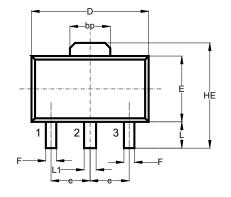
Fig .7 Power Derating Curve

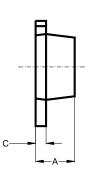


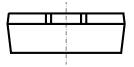


Package Outline (Dimensions in mm)

SOT-89

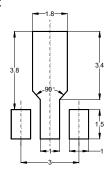






Unit	А	bp	С	D	Е	F	HE	е	L	L1
	1.6	1.60	0.5	4.6	2.6	0.45	4.25	1.5	1.05	0.51
mm	1.4	1.50	0.3	4.4	2.4	0.35	3.75	typ.	0.95	0.41

Recommended Soldering Footprint



Packing information

	Tape Width	Pitch		Ree	el Size	
Package	(mm)	(mm) mm inch		mm	inch	Per Reel Packing Quantity
007.00	40	0 . 0 4	0.045 + 0.004	178	7	1,000
SOT-89	12	8 ± 0.1	0.315 ± 0.004	330	13	4,000

Marking information

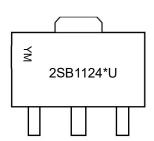
" 2SB1124*U " = Part No. (" * " Current Gain Group Code)

"YM" = Date Code Marking

"Y" = Year

"M" = Month

Font type: Arial



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